

# PMEG45U10EPD

45 V, 10 A extremely low VF MEGA Schottky barrier rectifier
16 December 2014 Product data sheet

### 1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOT1289 (CFP15) power and flat lead Surface-Mounted Device (SMD) plastic package.

#### 2. Features and benefits

- Average forward current: I<sub>F(AV)</sub> ≤ 10 A
- Reverse voltage: V<sub>R</sub> ≤ 45 V
- Extremely low forward voltage
- · High power capability due to clip-bonding technology and heat sink
- Small and thin SMD power plastic package, typical height 0.78 mm

### 3. Applications

- · Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Freewheeling application
- Reverse polarity protection
- Low power consumption application

### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; $T_{sp} \le$ 130 °C; square wave	-	-	10	Α
$V_R$	reverse voltage	T <sub>j</sub> = 25 °C	-	-	45	V
V <sub>F</sub>	forward voltage	$I_F = 10 \text{ A}; t_p \le 300  \mu\text{s}; \delta \le 0.02;$ $T_j = 25 ^{\circ}\text{C}; \text{ pulsed}$	-	430	490	mV
I <sub>R</sub>	reverse current	$V_R$ = 10 V; $t_p \le 3$ ms; $\delta \le 0.3$ ; $T_j$ = 25 °C; pulsed	-	20	50	μΑ
		$V_R$ = 45 V; $t_p \le 3$ ms; $\delta \le 0.3$ ; $T_j$ = 25 °C; pulsed	-	230	600	μΑ



## 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	Α	anode		K A
2	Α	anode	3	aaa-009063
3	K	cathode	2 CFP15 (SOT1289)	

## 6. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
PMEG45U10EPD	CFP15	plastic, thermal enhanced ultra thin SMD package; 3 leads; body: 5.8 x 4.3 x 0.78 mm	SOT1289			

## 7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG45U10EPD	4510 UUUU

# 8. Limiting values

### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	45	V
l <sub>F</sub>	forward current	T <sub>sp</sub> = 125 °C; δ = 1		-	14	Α
I <sub>F(AV)</sub>	average forward current	$δ$ = 0.5; f = 20 kHz; $T_{sp}$ ≤ 130 °C; square wave		-	10	A
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8 ms; $T_{j(init)}$ = 25 °C; square wave		-	180	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	1.4	W
			[2]	-	1.8	W
			[3]	-	3.1	W
T <sub>j</sub>	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C

PMEG45U10EPD

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Symbol	Parameter	Conditions	Min	Max	Unit
T <sub>stg</sub>	storage temperature		-65	150	°C

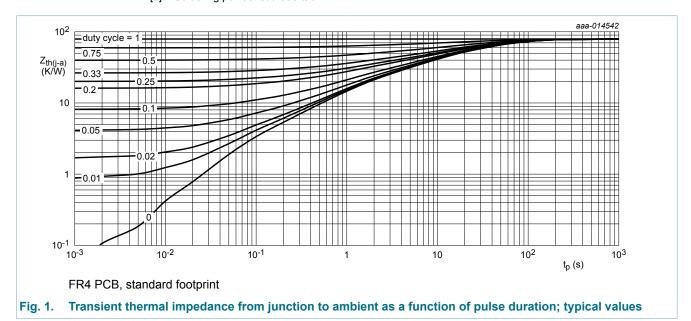
- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [3] Device mounted on a ceramic Printed-Circuit Board (PCB), Al<sub>2</sub>O<sub>3</sub>, standard footprint.

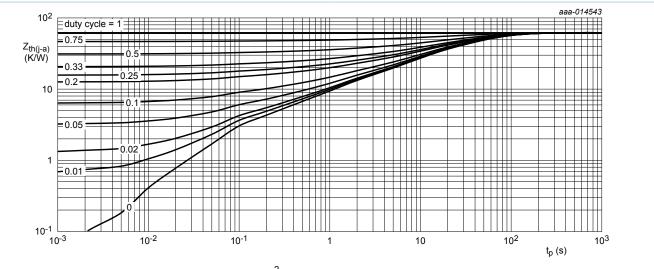
### 9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance	1	[1][2]	-	-	90	K/W
	from junction to ambient		[1][3]	-	-	70	K/W
amblem	ambient		[1][4]	-	-	40	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		[5]	-	-	3	K/W

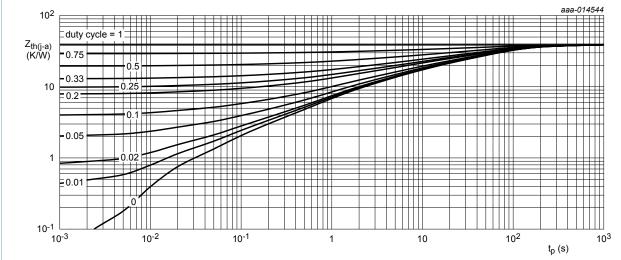
- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [5] Soldering point of cathode tab.





FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



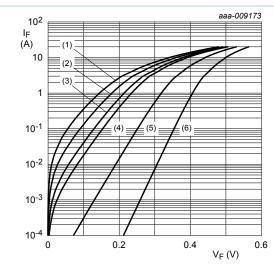
Ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint

Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

## 10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
$V_{(BR)R}$	reverse breakdown voltage	$I_R$ = 5 mA; $T_j$ = 25 °C; $t_p$ ≤ 1.2 ms; $\delta$ ≤ 0.12; pulsed	45	-	-	V	
V <sub>F</sub>	forward voltage	$I_F$ = 1 A; $t_p \le 300$ μs; $δ \le 0.02$ ; $T_j$ = 25 °C; pulsed	-	314	360	mV	
			$I_F$ = 2 A; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C; pulsed	-	338	-	mV
		$I_F$ = 3 A; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C; pulsed	-	355	-	mV	
		$I_F$ = 5 A; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C; pulsed	-	380	430	mV	
		$I_F$ = 10 A; $t_p \le 300$ μs; $δ \le 0.02$ ; $T_j$ = 25 °C; pulsed	-	430	490	mV	
I <sub>R</sub> reverse current	$V_R$ = 5 V; $t_p$ ≤ 3 ms; $\delta$ ≤ 0.3; $T_j$ = 25 °C; pulsed	-	15	-	μA		
		$V_R$ = 10 V; $t_p \le 3$ ms; $\delta \le 0.3$ ; $T_j$ = 25 °C; pulsed	-	20	50	μA	
		$V_R = 30 \text{ V}; t_p \le 3 \text{ ms}; \delta \le 0.3;$ $T_j = 25 ^{\circ}\text{C}; \text{ pulsed}$	-	65	-	μA	
		$V_R$ = 45 V; $t_p \le 3$ ms; $\delta \le 0.3$ ; $T_j$ = 25 °C; pulsed	-	230	600	μA	
		$V_R = 10 \text{ V; } t_p \le 3 \text{ ms; } \delta \le 0.3;$ $T_j = 125 \text{ °C; pulsed}$	-	20	-	mA	
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	1170	-	pF	
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	390	-	pF	
t <sub>rr</sub>	reverse recovery time step recovery	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 \text{ °C}$	-	34	-	ns	
t <sub>rr</sub>	reverse recovery time ramp recovery	$dI_F/dt = 200 \text{ A/}\mu\text{s}; T_j = 25 ^{\circ}\text{C}; I_F = 6 \text{ A};$ $V_R = 26 \text{ V}$	-	16	-	ns	
$V_{FRM}$	peak forward recovery voltage	$I_F = 0.5 \text{ A}; dI_F/dt = 20 \text{ A/}\mu\text{s}; T_j = 25 ^{\circ}\text{C}$	-	300	-	mV	



pulsed condition

(1)  $T_i = 150 \, ^{\circ}C$ 

(2)  $T_i = 125 \, ^{\circ}C$ 

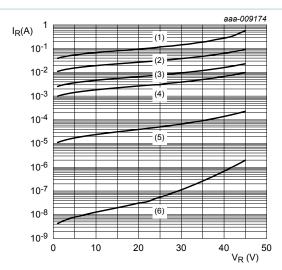
(3)  $T_i = 100 \, ^{\circ}C$ 

(4)  $T_i = 85 \, ^{\circ}C$ 

(5) T<sub>j</sub> = 25 °C

(6)  $T_i = -40 \, ^{\circ}C$ 

Fig. 4. Forward current as a function of forward voltage; typical values



pulsed conditions

(1)  $T_i = 150 \, ^{\circ}C$ 

(2)  $T_i = 125 \, ^{\circ}C$ 

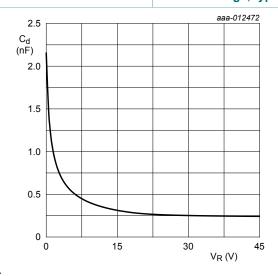
(3)  $T_i = 100 \,^{\circ}\text{C}$ 

(4)  $T_i = 85 \, ^{\circ}C$ 

(5) T<sub>j</sub> = 25 °C

(6)  $T_i = -40 \, ^{\circ}C$ 

Fig. 5. Reverse current as a function of reverse voltage; typical values



 $f = 1 \text{ MHz}; T_{amb} = 25 \text{ }^{\circ}\text{C}$ 

Fig. 6. Diode capacitance as a function of reverse voltage; typical values

## 11. Test information

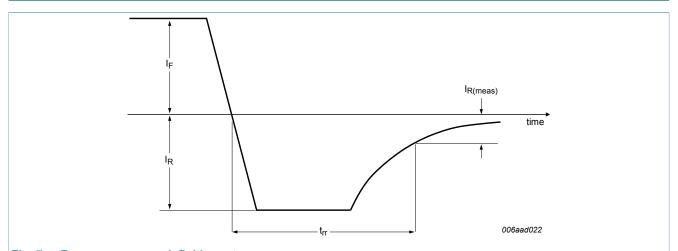


Fig. 7. Reverse recovery definition; step recovery

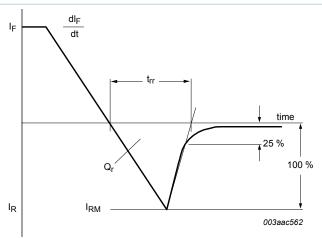


Fig. 8. Reverse recovery definition; ramp recovery

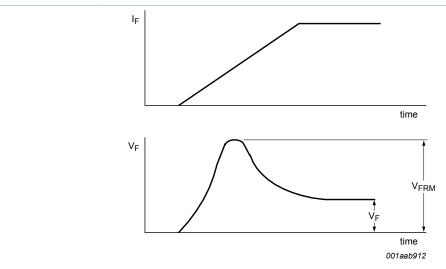
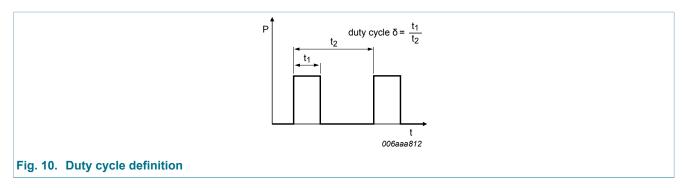


Fig. 9. Forward recovery definition

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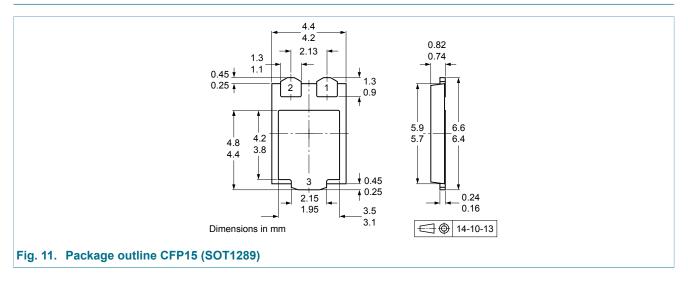
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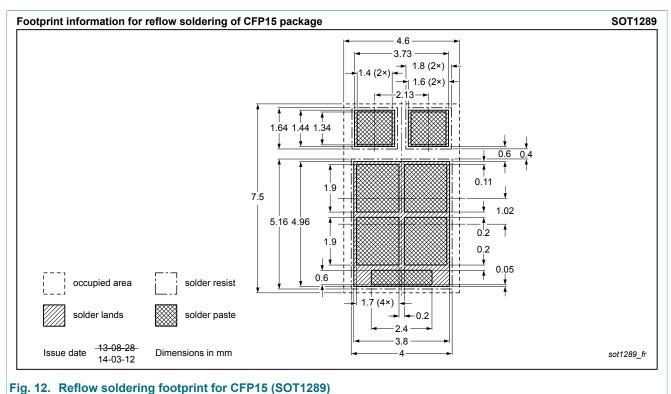


The current ratings for the typical waveforms are calculated according to the equations:  $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,  $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current.

## 12. Package outline



## 13. Soldering



## 14. Revision history

### Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes		
PMEG45U10EPD v.3	20141216	Product data sheet	-	PMEG45U10EPD v.2		
Modifications:	Package outline dra	Package outline drawing updated				
PMEG45U10EPD v.2	20140416	Product data sheet	-	PMEG45U10EPD v.1		
PMEG45U10EPD v.1	20140217	Objective data sheet	-	-		

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Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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